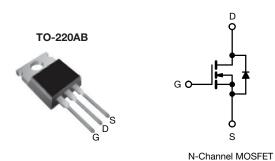
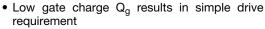


## **Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	500			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	1.4		
Q <sub>g</sub> max. (nC)	24			
Q <sub>gs</sub> (nC)	6.3			
Q <sub>gd</sub> (nC)	11			
Configuration	Single			

### **FEATURES**





 Improved gate, avalanche and dynamic dV/dt RoHS ruggedness

- Fully characterized capacitance and avalanche voltage and current
- Effective C<sub>oss</sub> specified
- · Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- High speed power Switching

### TYPICAL SMPS TOPOLOGIES

- · Two transistor forward
- Half bridge
- Full bridge

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF830APbF
Lead (Pb)-free and halogen-free	IRF830APbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS (TC</b>	= 25 $^{\circ}$ C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	500	V	
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current	V -140V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		5.0		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	3.2	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	20	1	
Linear derating factor				0.59	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	230	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	5.0	А	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum power dissipation	T <sub>C</sub> =	25 °C	$P_{D}$	74	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	5.3	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	- °C	
Soldering recommendations (peak temperature) <sup>d</sup>	For	10 s		300	1	
Mounting torque	6 22 or I	6-32 or M3 screw		10	lbf ⋅ in	
Mounting torque	U-32 OF IVIS SCIEW			1.1	N⋅m	

### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Starting  $T_J$  = 25 °C, L = 18 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 5.0 A (see fig. 12)
- c.  $I_{SD} \le 5.0$  A,  $dI/dt \le 370$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_{J} \le 150$  °C
- d. 1.6 mm from case



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# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62			
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.7			

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.60	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_{D} = 250  \mu A$	2.0	-	4.5	V
Gate-source leakage	I <sub>GSS</sub>	V	V <sub>GS</sub> = ± 30 V		-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>		$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$		-	25 250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>		I <sub>D</sub> = 3.0 A b	-	-	1.4	Ω
Forward transconductance	9fs		V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3.0 A <sup>b</sup>		-	-	S
Dynamic		_			L		L
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	620	-	pF
Output capacitance	C <sub>oss</sub>		$V_{DS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		93	-	
Reverse Transfer capacitance	C <sub>rss</sub>	$f = 1.0 \text{ MHz, see fig. 5}$ $V_{GS} = 0 \text{ V; } V_{DS} = 1.0 \text{ V, f} = 1.0 \text{ MHz}$ $V_{GS} = 0 \text{ V; } V_{DS} = 400 \text{ V, f} = 1.0 \text{ MHz}$ $V_{GS} = 0 \text{ V; } V_{DS} = 0 \text{ V to } 400 \text{ V}^{c}$		-	4.3	-	
Output capacitance	C <sub>oss</sub>				886		
Output capacitance	C <sub>oss</sub>				27		
Effective output capacitance	C <sub>oss</sub> eff.				39		
Total gate charge	Qg		V <sub>GS</sub> = 10 V	-	-	24	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	6.3	
Gate-drain charge	Q <sub>gd</sub>		See fig. 6 and 16	-	-	11	
Turn-on delay time	t <sub>d(on)</sub>			-	10	-	- ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD} = 250 \text{ V}, I_D = 5.0 \text{ A},$		21	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_g$ = 14 $\Omega$ , $R_D$ = 49 $\Omega$ , see fig. 10 $^b$		-	21	-	
Fall time	t <sub>f</sub>			-	15	-	
Gate input resistance	Rg	f = 1 MHz, open drain		1.7	-	10.7	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I <sub>S</sub>	showing t	MOSFET symbol showing the		-	5.0	^
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		=	-	20	A
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C,	$T_J = 25  ^{\circ}\text{C},  I_S = 5.0  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_{\rm J} = 25~{\rm ^{\circ}C}, I_{\rm F} = 5.0~{\rm A}, dI/dt = 100~{\rm A/\mu s}^{\rm b}$		-	430	650	ns
Body diode reverse recovery charge	$Q_{rr}$			-	1.62	2.4	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L				112)	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

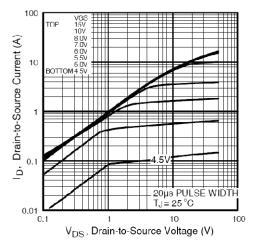


Fig. 1 - Typical Output Characteristics

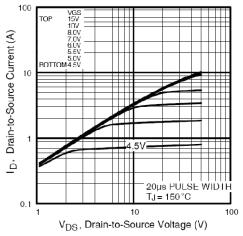


Fig. 2 - Typical Output Characteristics

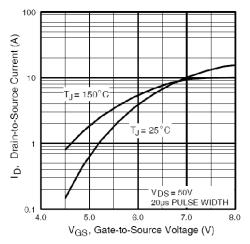


Fig. 3 - Typical Transfer Characteristics

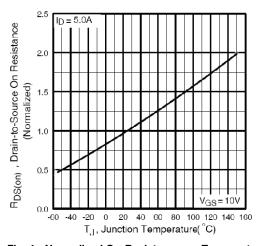


Fig. 4 - Normalized On-Resistance vs. Temperature

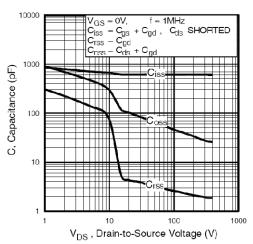


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

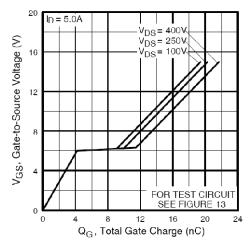


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



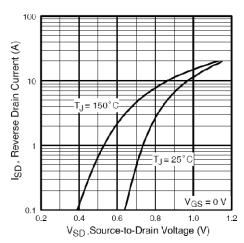


Fig. 7 - Typical Source-Drain Diode Forward Voltage

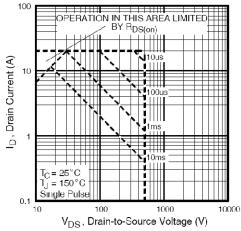


Fig. 8 - Maximum Safe Operating Area

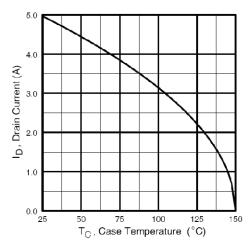


Fig. 9 - Maximum Drain Current vs. Case Temperature

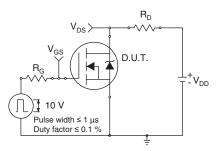


Fig. 10a - Switching Time Test Circuit

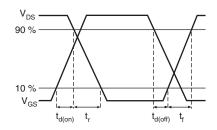


Fig. 10b - Switching Time Waveforms



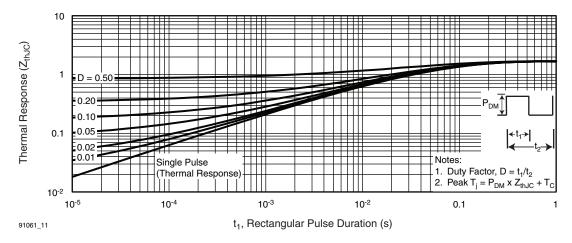


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

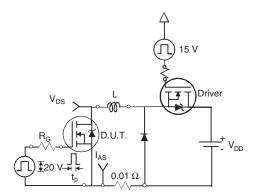


Fig. 12a - Unclamped Inductive Test Circuit

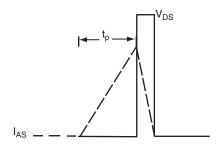


Fig. 12b - Unclamped Inductive Waveforms

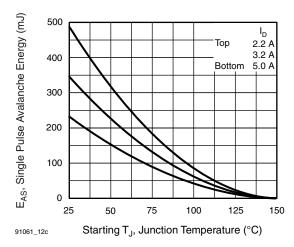


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

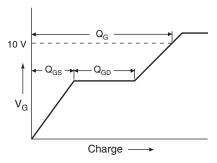


Fig. 12d - Basic Gate Charge Waveform



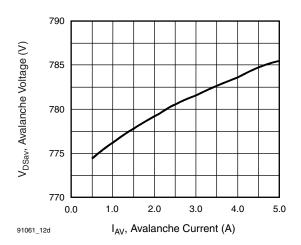


Fig. 13a - Typical Drain-to-Source Voltage vs. Avalanche Current

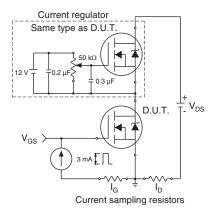
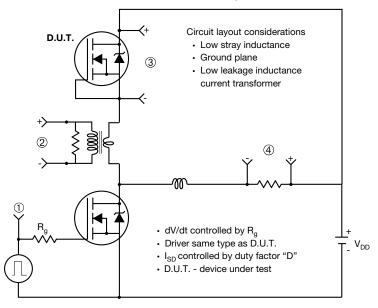


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



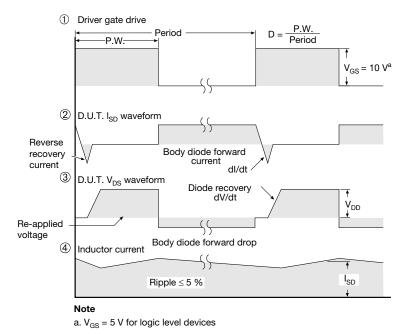


Fig. 14 - For N-Channel

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